

PolarHT[™] HiPerFET Power MOSFET

IXFH 120N15P IXFT 120N15P

N-Channel Enhancement Mode Avalanche Energy Rated Fast Intrinsic Diode

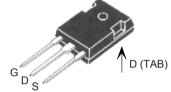


$V_{\scriptscriptstyle DSS}$	=	150	V
I _{D25}	=	120	Α
R _{DS(on)}	≤	16	$m\Omega$
t _{rr}	≤	200	ns

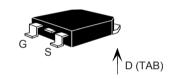
Symbol	Symbol Test Conditions		Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ} C \text{ to } 175^{\circ} C$ $T_J = 25^{\circ} C \text{ to } 175^{\circ} C; R_{GS} = 1 MΩ$	150 150	V		
V _{DSS} V _{GSM}	Continuous Transient	±20 ±30	V		
I _{D25}	T _C =25°C	120	Α		
I _{L(RMS)}	External lead current limit	75	Α		
I _{DM}	$T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$	260	Α		
I _{AR}	T _C = 25° C	60	Α		
E _{AR}	T _C = 25° C	60	mJ		
E _{AS}	T _C = 25° C	2.0	J		
dv/dt	$I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150^{\circ}$ C, $R_{G} = 4 \Omega$	10	V/ns		
$\overline{\mathbf{P}_{\mathrm{D}}}$	T _C =25°C	600	W		
T _J		-55 +175	°C		
T _{.m}		175	°C		
T _{stg}		-55 +150	°C		
T,	1.6 mm (0.062 in.) from case for 10 s	300	°C		
T _{SOLD}	Plastic case for 10 s	260	°C		
M _d	Mounting torque (TO-3P)	1.13/10	Nm/lb.in.		
Weight	TO-247 TO-268	6.0 5.0	g g		

	10-208			5.0	<u>g</u>
Symbol (T _J = 25° C, 1	Test Conditions unless otherwise specified)	Ch Min.	aracter Typ.	istic Va ∣ Max	
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	150			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$	3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$ $T_{J} = 175^{\circ} C$			25 500	μA μA
R _{DS(on)}	V_{GS} = 10 V, I_{D} = 0.5 I_{D25} Pulse test, t ≤300 µs, duty cycle d ≤ 2 %			16	mΩ

TO-247 (IXFH)



TO-268 (IXFT)



G = Gate	D = Drain
S = Source	TAB = Drain

Features

- ¹ International standard packages
- ¹ Unclamped Inductive Switching (UIS) rated
- ¹ Low package inductance
 - easy to drive and to protect

Advantages

- ^I Easy to mount
- Space savings
- High power density

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Symbo	ol	Test Conditions $(T = 25^{\circ})$	Characteristic Values °C, unless otherwise specified)		
		(1, 25)	Min.	Typ.	Max.
g_{fs}		V_{DS} = 10 V; I_{D} = 0.5 I_{D25} , pulse test	40	60	S
C _{iss})			4900	pF
\mathbf{C}_{oss}	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1300	pF
\mathbf{C}_{rss}	J			330	pF
t _{d(on)})			33	ns
t _r		$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		42	ns
$\mathbf{t}_{d(off)}$		$R_{_{G}} = 4 \Omega $ (External)		85	ns
t _f)			26	ns
$\mathbf{Q}_{g(on)}$)			150	nC
\mathbf{Q}_{gs}	}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 0.5 \text{ I}_{D25}$		40	nC
\mathbf{Q}_{gd}	J			80	nC
R _{thJC}		•			0.25° C/W
R _{thCS}		(TO-3P)		0.21	° C/W

Source-Drain Diode

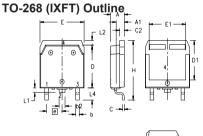
Characteristic Values (T, = 25°C, unless otherwise specified)

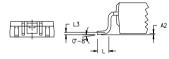
Symbol	Test Conditions Min.	∣Тур.	Max.	
Is	$V_{GS} = 0 V$		120	Α
I _{sm}	Repetitive		260	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤300 µs, duty cycle d≤ 2 %		1.5	V
t _{rr} Q _{RM}	$\begin{cases} I_{F} = 25 \text{ A, } -\text{di/dt} = 100 \text{ A/}\mu\text{s} \\ V_{R} = 100 \text{ V, } V_{GS} = 0 \text{ V} \end{cases}$	600	200	ns nC A

TO-247 (IXFH) Outline

Terminals: 1 - Gate 2 - Drain 3 - Source Tab - Drain

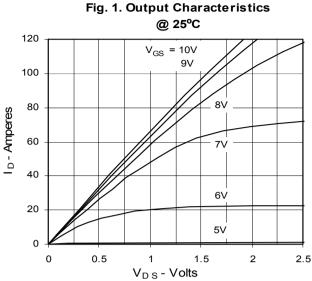
Dim.	Millimeter		Inc	hes		
	Min.	Max.	Min.	Max.		
Α	4.7	5.3	.185	.209		
A ₁	2.2	2.54	.087	.102		
A ₂	2.2	2.6	.059	.098		
b	1.0	1.4	.040	.055		
b ₁	1.65	2.13	.065	.084		
b ₂	2.87	3.12	.113	.123		
С	.4	.8	.016	.031		
D	20.80	21.46	.819	.845		
Е	15.75	16.26	.610	.640		
е	5.20	5.72	0.205	0.225		
L	19.81	20.32	.780	.800		
L1		4.50		.177		
ØP	3.55	3.65	.140	.144		
Q	5.89	6.40	0.232	0.252		
R	4.32	5.49	.170	.216		
S	6.15	BSC	242	BSC		

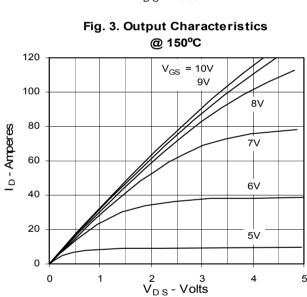


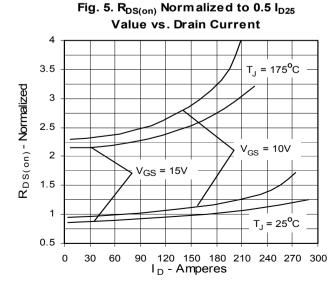


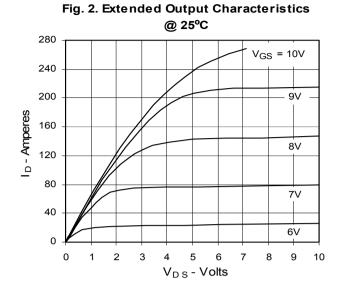
Terminals: 1 - Gate 2 - Drain 3 - Source Tab - Drain

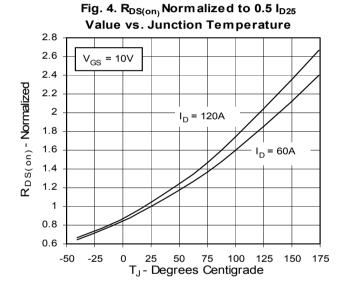
MYZ	INCHES		MILLIMETERS		
2114	MIN	MAX	MIN	MAX	
Α	.193	.201	4.90	5.10	
A1	.106	.114	2.70	2.90	
A2	.001	.010	0.02	0.25	
Ø	.045	.057	1.15	1.45	
b2	.075	.083	1.90	2.10	
О	.016	.026	0.40	0.65	
C2	.057	.063	1.45	1.60	
D	.543	.551	13.80	14.00	
D1	.488	.500	12.40	12.70	
Ε	.624	.632	15.85	16.05	
E1	.524	.535	13.30	13.60	
е	.215	BSC	5.45 BSC		
Н	.736	.752	18.70	19.10	
7	.094	.106	2.40	2.70	
L1	.047	.055	1.20	1.40	
L2	.039	.045	1.00	1.15	
L3	.010 BSC		0.25 BSC		
L4	.150	.161	3.80	4.10	
L2 L3	.039 .010	.055 .045 BSC	1.20 1.00 0.25	1.15 BSC	

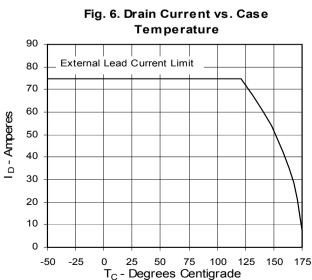












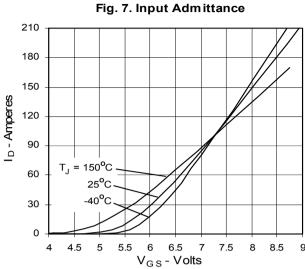
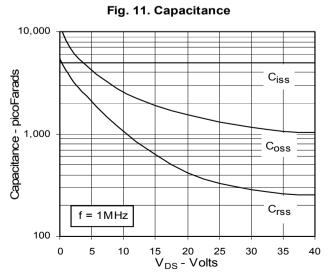
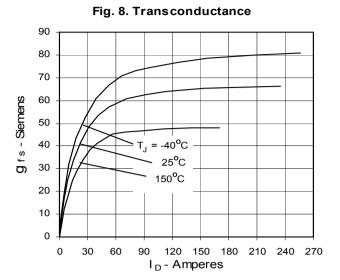
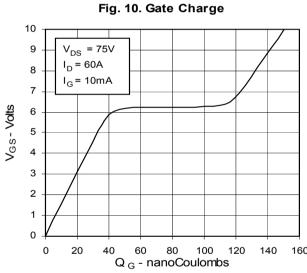


Fig. 9. Source Current vs.

Source-To-Drain Voltage 300 250 200 Is-Amperes 150 100 T_J = 150^oC 50 $T_{.1} = 25^{\circ}C$ 0 0.4 0.6 1.2 1.4 1.6 1.8 V_{SD} - Volts







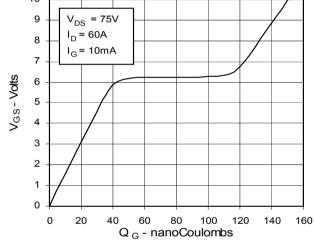
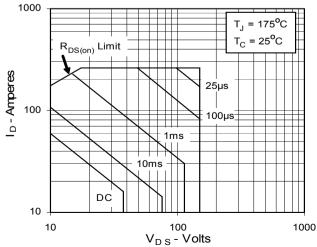


Fig. 12. Forward-Bias Safe Operating Area



IXYS reserves the right to change limits, test conditions, and dimensions.



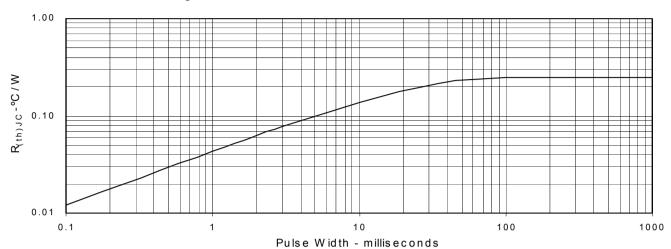


Fig. 13. Maximum Transient Thermal Resistance

